Call for Applications : Matchmaking Event at
MIRAI 2.0 Digital Research and Innovation Week

"International Collaboration in a Digital Era – Fostering Innovative Minds for the Future"
June 7 – 11, 2021 Topic AI

The following are the application guidelines to participate in the matchmaking event at Research and Innovation Week, which will be held online from June 7 – 11, 2021, mainly for early career researchers from the member universities. Through this event, you can connect with researchers within your field

At this event, you can participate in Oral Presentation- Introducing your own research on the premise of promoting international joint research. About 15 minutes per presentation. If there are many applications, a limited number will be selected.

■About the program

About MIRAI 2.0

The MIRAI Project is a collaboration between 19 Swedish and Japanese universities aiming to promote research collaboration and support early career researchers within the following fields:

Fields

・ Ageing

・ Material Science

・ Sustainability

・ Artificial Intelligence

・ Innovation and Entrepreneurship

Activities:

・ Scientific events in Sweden and Japan

・ Short courses for PhD's

・ Networking possibilities

・ Seed funding for research collaboration

・ Travel grants

・ Opportunities for Academia-Industry collaboration

Check the website: http://www.mirai.nu/

About the program

Field: AI

Sub-topics: Robotics

> Knowledge representation
>
> Perception
>
> Reasoning
>
> Big Data Analytics
>
> Natural Language processing
>
> Machine Learning
>
> Multi-agent systems
>
> AI enabled applications
>
> Bio-inspired robotics
>
> Human – Robot Interaction
>
> Statistical learning
>
> Planning and Optimization
>
> AI in the edge/cloud
>
> Ethics of AI

Format: Online

Dates: Monday, June 7 – Friday, June 11, 2021

Eligibility: Young researchers at MIRAI member universities, PhD＋within the past 10 years

Number of Presenter: 10 (10 From all MIRAI partner universities from Japanese side)

Time for a presentation: 15 minutes

Program: https://www.mirai.nu/mirai-2-0-research-and-innovation-week-2021/

Fee: Free

How to apply: Access the following URL and fill in the form.

https://my.waseda.jp/application/noauth/application-detail-noauth?param=yRyfaNQGpIIb6ceY9b9E9Q

Application Deadline: Friday, April 16, 2021

Screening: The MIRAI management members will conduct screening based on the application documents.

Selection Notification: Applicants will be notified of the screening results via email.

Contact:

Global Engagement Division, Tohoku University

Email: kokusai-k@grp.tohoku.ac.jp

Other

All applicants will be asked by the host university to register for MIRAI 2.0 Digital Research and Innovation Week around mid-April. At that time, it will be necessary to submit the CV and the research abstract.